

$I_V = 3200 \text{ mcd}$, $V_F = 2.9 \text{ V}$
Ultra-high Brightness, Surface Mount LED
SEP1P81L19DA



Preliminary

Data Sheet

Description

The SEP1P81L19DA is a surface mount amber LED. The product includes a protection diode for ESD protection.

Features

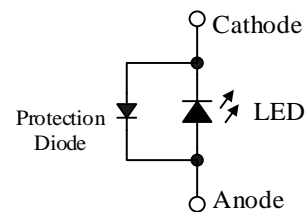
- Color----- Amber
- Luminous Intensity, I_V -- 3200 mcd (typ.) ($I_F = 50 \text{ mA}$)
- Forward Voltage, V_F ----- 2.9 V (typ.) ($I_F = 50 \text{ mA}$)
- Chromaticity (x, y)----- (0.640, 0.350)
- Viewing Angle, $2\theta_{1/2}$ ----- 120 deg
- MSL 3
- RoHS Compliant
- Pb-free, Reflow Soldering
- High Reliability

Applications

- Automotive Interior
- Switch
- Indicator

Package

Dimensions (L × W × H): 2.8 × 3.5 × 0.7 mm



Not to scale

This product uses technology licensed from the National Institute for Materials Science (NIMS).
This technology is protected by worldwide patents, including Japan Patent No. 3931239 owned by NIMS.

Absolute Maximum RatingsUnless specifically noted, $T_A = 25\text{ }^{\circ}\text{C}$.

Parameter	Symbol	Conditions	Rating	Unit
Power Dissipation	P_D		288	mW
Forward Current	I_F		80	mA
Pulse Forward Current	I_{FP}	Frequency = 1 kHz Pulse Width $\leq 100\text{ }\mu\text{s}$	100	mA
Reverse Current	I_R		10	mA
Operating Temperature	T_{OP}		-40 to 100	$^{\circ}\text{C}$
Storage Temperature	T_{STG}		-40 to 100	$^{\circ}\text{C}$
Junction Temperature	T_J		150	$^{\circ}\text{C}$
Thermal Resistance	$\theta_{(J-A)}$		80	$^{\circ}\text{C/W}$
	$\theta_{(J-S)}$		25	$^{\circ}\text{C/W}$

Electrical / Optical CharacteristicsUnless specifically noted, $T_A = 25\text{ }^{\circ}\text{C}$.

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Unit
Forward Voltage	V_F	$I_F = 50\text{ mA}$	2.5	2.9	3.6	V
Reverse Voltage	V_R	$I_R = 1\text{ mA}$	—	0.8	—	V
Luminous Intensity	I_V	$I_F = 50\text{ mA}$	2263	3200	4525	mcd
Chromaticity	x	$I_F = 50\text{ mA}$	—	0.640	—	—
	y		—	0.350	—	—
Viewing Angle	$2\theta_{1/2}$	$I_F = 50\text{ mA}$	—	120	—	deg

Mechanical Characteristics

Parameter	Conditions	Min.	Typ.	Max.	Unit
Package Weight		—	0.0214	—	g

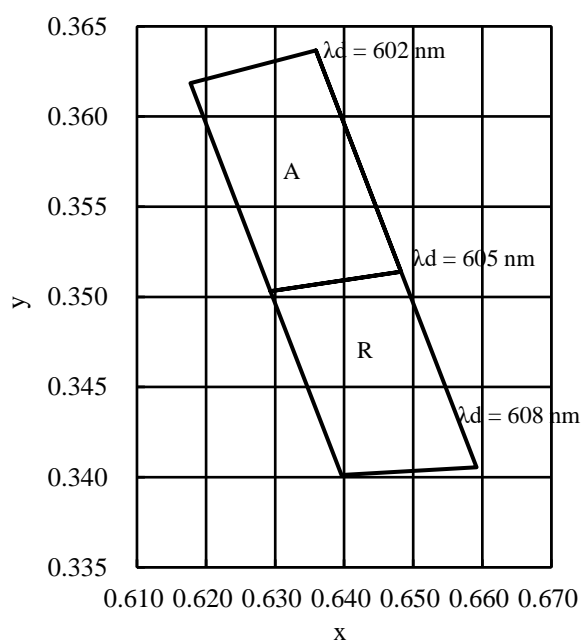
Luminous Intensity BinsThe values have a tolerance of $\pm 10\%$.

Bin Number	Luminous Intensity Range	Unit
C	2263 to 3200	mcd
D	3200 to 4525	mcd

Chromaticity Bins

The values have a tolerance of ± 0.01 .

Bin Number	x	y
A	0.6359	0.3637
	0.6482	0.3514
	0.6293	0.3503
	0.6177	0.3618
R	0.6482	0.3514
	0.6592	0.3406
	0.6396	0.3401
	0.6293	0.3503



Derating Curves

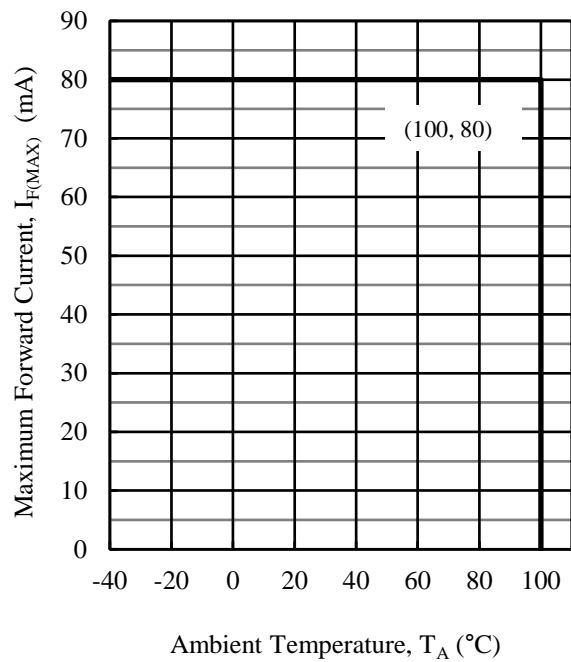


Figure 1. $I_{F(MAX)}$ vs. T_A

Characteristic Curves

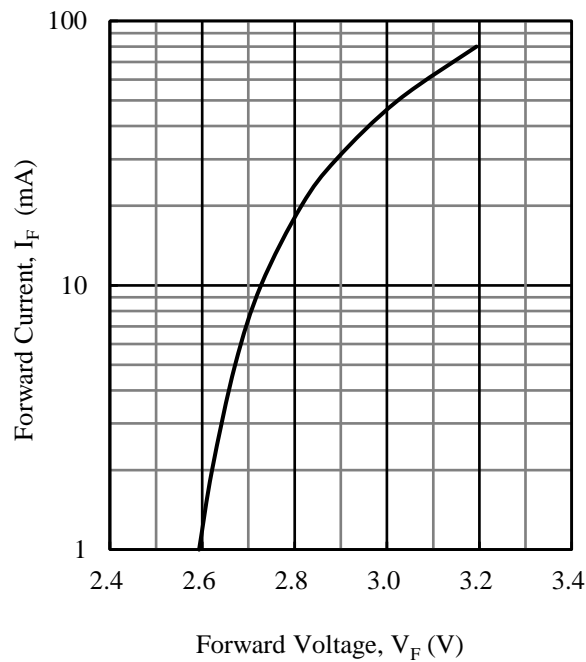


Figure 2. I_F vs. V_F

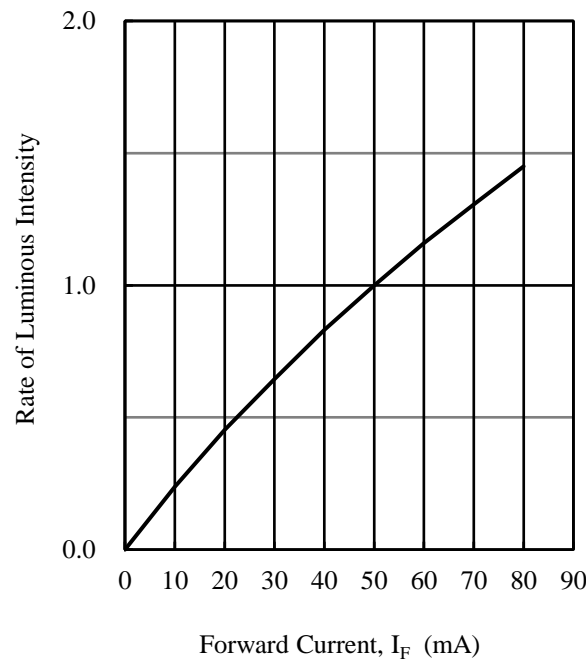


Figure 3. Rate of Luminous Intensity vs. I_F

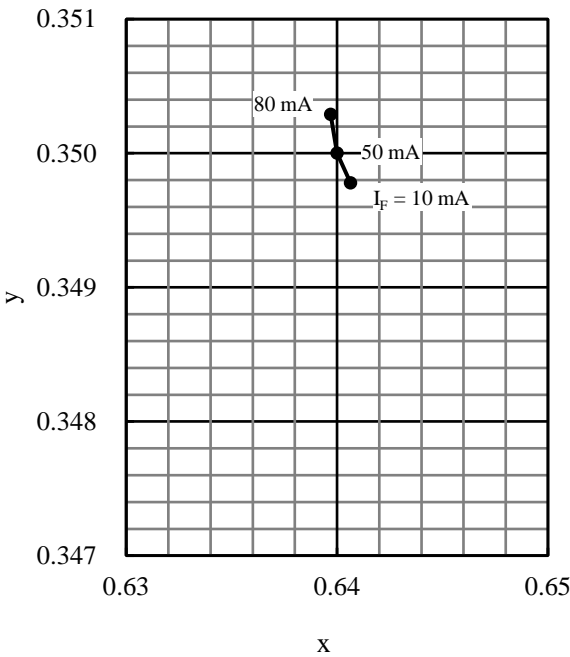


Figure 4. I_F vs. Chromaticity

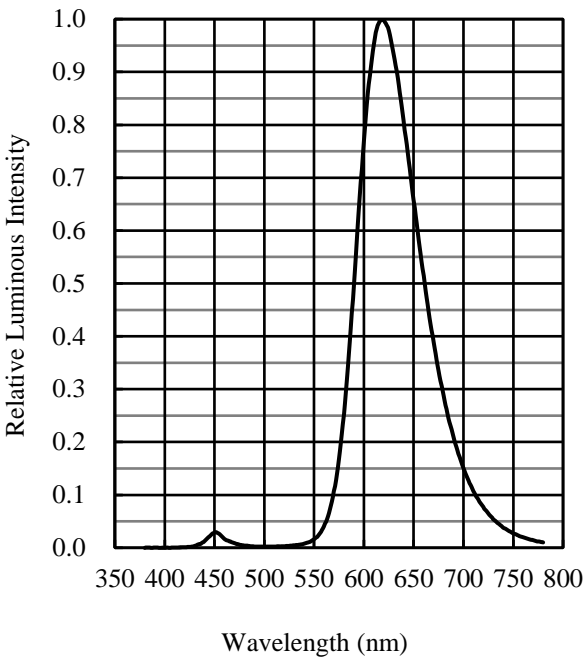


Figure 5. Spectrum

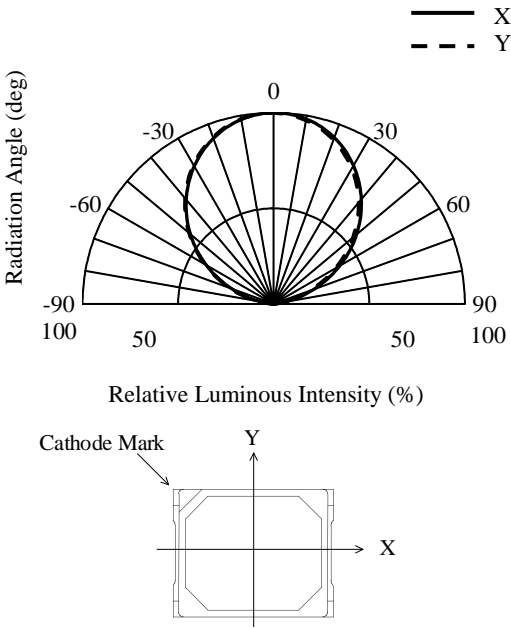
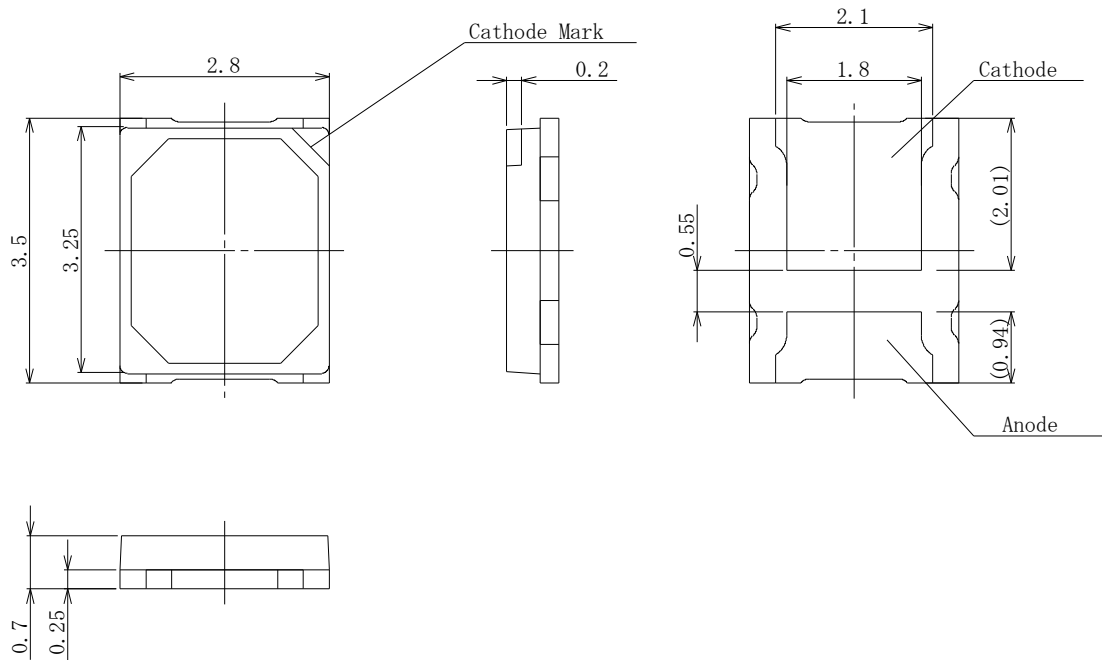


Figure 6. Directivity

Physical Dimensions

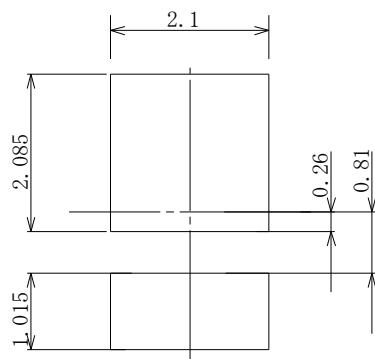
• Surface Mount (2.8 × 3.5 × 0.7 mm)



NOTES:

- Dimensions in millimeters
- Tolerance: ± 0.2 mm
- All the values in parentheses are reference dimensions.
- Pb-free (RoHS compliant)
- MSL 3 (Moisture Sensitivity Level 3)

• Land Pattern Example

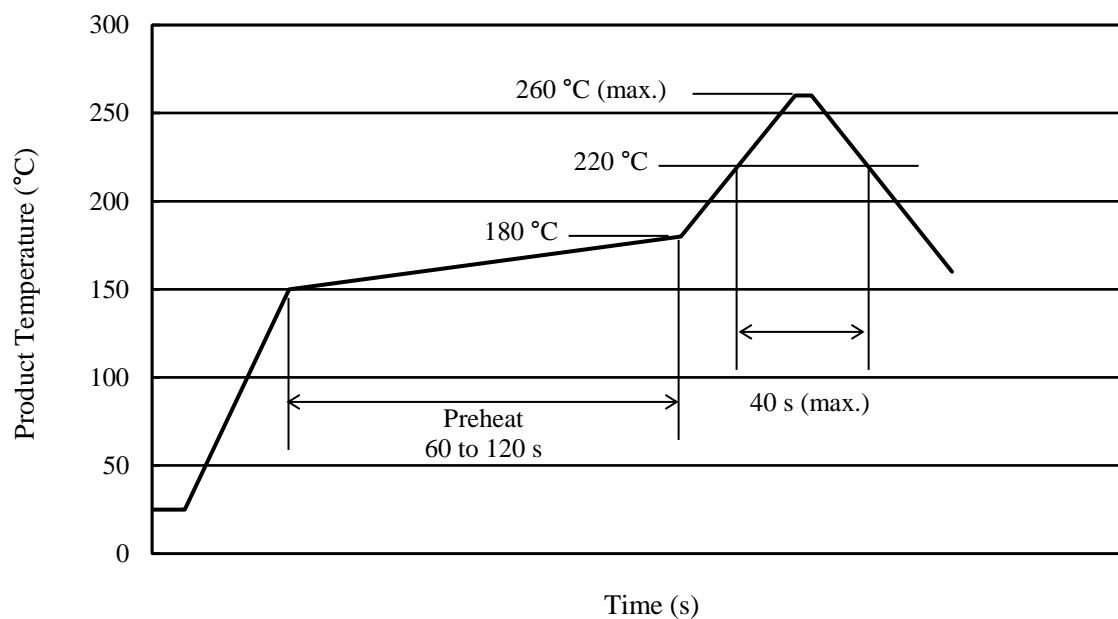


Unit: mm

Soldering Conditions

When soldering the products, it is required to minimize the working time within the following limits:

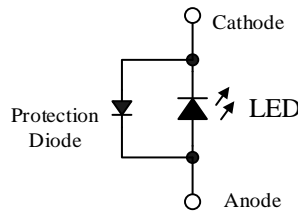
- Reflow:
 - Preheat: 150 to 180 °C / 60 to 120 s
 - Solder heating: 220 °C / 40 s (260 °C peak, 2 times)
- Soldering iron: 350 ±10 °C / 3 s, 1 time

● Reference Reflow Profile

Precautions for Use**• Measures for Electrostatic Discharge (ESD)**

In general, InGaN-based elements such as blue LEDs are very sensitive to ESD. For enhanced ESD withstand capability, this product is designed to include a surge protection diode as shown in the figure below. Therefore, the following ESD withstand capabilities are ensured: ≥ 200 V on machine model ($C = 200$ pF, $R = 0\ \Omega$), and ≥ 2000 V on human body model ($C = 100$ pF, $R = 1.5\ \text{k}\Omega$). Note that, however, all the values mentioned above are not guaranteed.

When using the product, care should be taken not to apply a voltage in the opposite direction of the LED. If a voltage is applied in the opposite direction of the LED, the surge protection diode becomes conductive, and then an unintended current may flow through the set.

**• Other**

- After soldering the product, care should be taken not to apply mechanical stress or excessive vibration until it cools to room temperature.
- Do not cool the product rapidly.
- When mounting the product on a board, mounting position and orientation should be taken into account so that any stress due to board warpage is not applied to the product.
- Do not touch the encapsulating resin of the product with sharp objects such as a tweezer or fingernails. Also, do not use the product again after removal.
- Do not touch the product after mounting it on a board.
- The product emits a high-power light. Therefore, care should be taken not to look at the light emission directly for a long time because it may hurt your eyes.
- Use the product at rated current (sorting current) as much as possible. When the product is used at a current lower than the rated current (sorting current), a variation in forward voltage or luminous intensity may increase. Therefore, care should be taken for such variation when you use the product at low current.

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